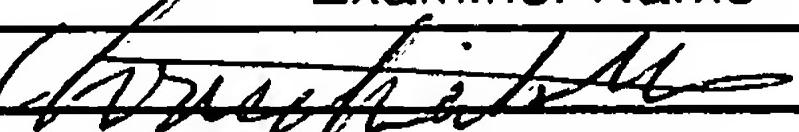
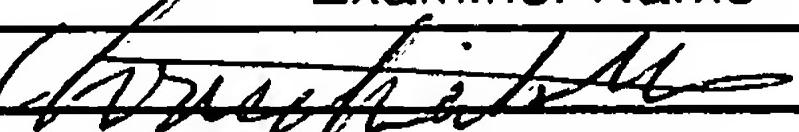
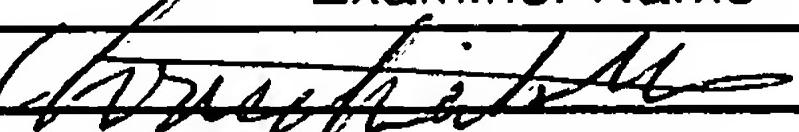


ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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Title of Invention	STABILIZING COPPER OVERLAYER FOR ENHANCED C4 INTERCONNECT RELIABILITY																																																																						
<p>Application Number :</p> <p>Confirmation Number:</p> <p>First Named Applicant: James Bartelo</p> <p>Attorney Docket Number: FIS920030197US1</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: (5705428 or 5937320 or 6127731 or 6140703 or 6293457 or 6306751 or 6373137).pn</p>																																																																							
<h2>US Patent Documents</h2> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td>1.</td><td>1</td><td>5705428</td><td>1998-01-06</td><td>Liu, et al.</td><td></td><td>438</td><td>643</td></tr><tr><td>1.</td><td>2</td><td>5937320</td><td>1999-08-10</td><td>Andricacos, et al.</td><td></td><td>438</td><td>614</td></tr><tr><td>1.</td><td>3</td><td>6127731</td><td>2000-10-03</td><td>Hoffmeyer</td><td></td><td>257</td><td>750</td></tr><tr><td>1.</td><td>4</td><td>6140703</td><td>2000-10-31</td><td>Cronin, et al.</td><td></td><td>257</td><td>766</td></tr><tr><td>1.</td><td>5</td><td>6293457</td><td>2001-09-25</td><td>Srivastava, et al.</td><td></td><td>228</td><td>254</td></tr><tr><td>1.</td><td>6</td><td>6306751</td><td>2001-10-23</td><td>Patel, et al.</td><td></td><td>438</td><td>614</td></tr><tr><td>1.</td><td>7</td><td>6373137</td><td>2002-04-16</td><td>McTeer</td><td></td><td>257</td><td>762</td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	1.	1	5705428	1998-01-06	Liu, et al.		438	643	1.	2	5937320	1999-08-10	Andricacos, et al.		438	614	1.	3	6127731	2000-10-03	Hoffmeyer		257	750	1.	4	6140703	2000-10-31	Cronin, et al.		257	766	1.	5	6293457	2001-09-25	Srivastava, et al.		228	254	1.	6	6306751	2001-10-23	Patel, et al.		438	614	1.	7	6373137	2002-04-16	McTeer		257	762
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